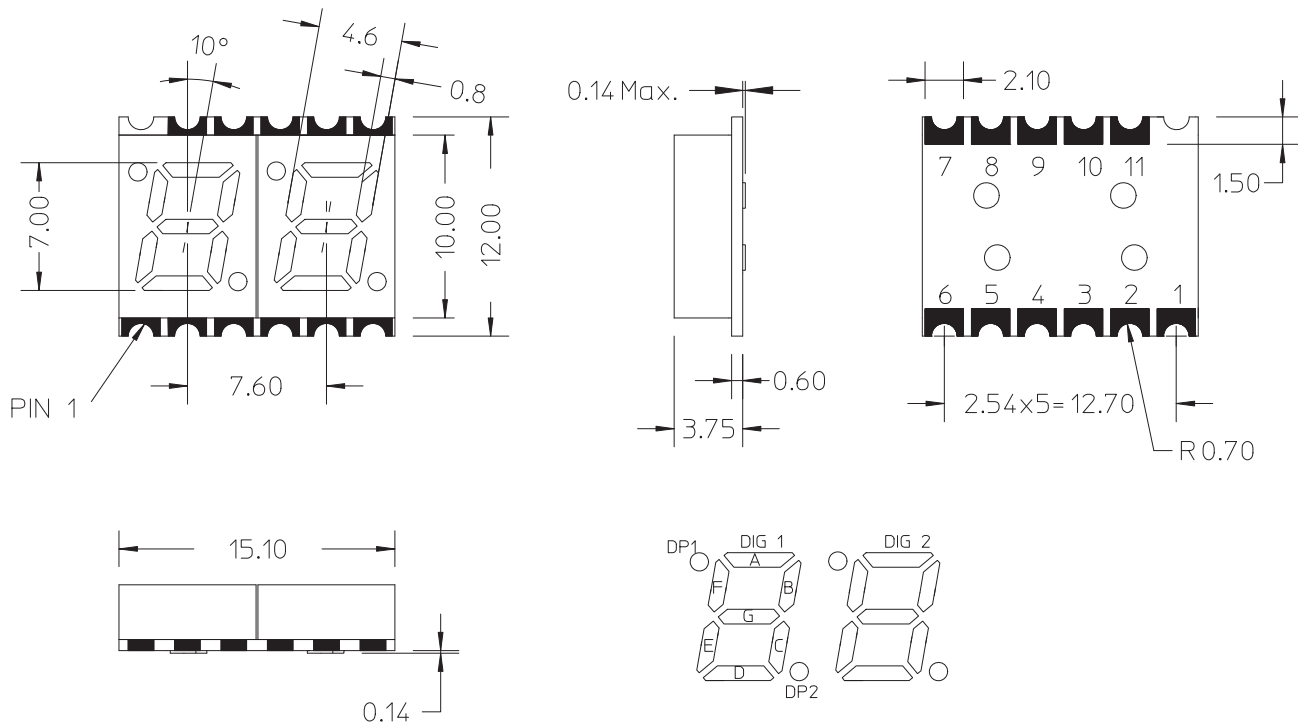


Package Dimensions



NOTE:

1. All dimensions are in millimeters (inches).
2. Tolerance ± 0.25 mm (0.01 in.) unless otherwise noted.

Pin Connection (Common Anode)

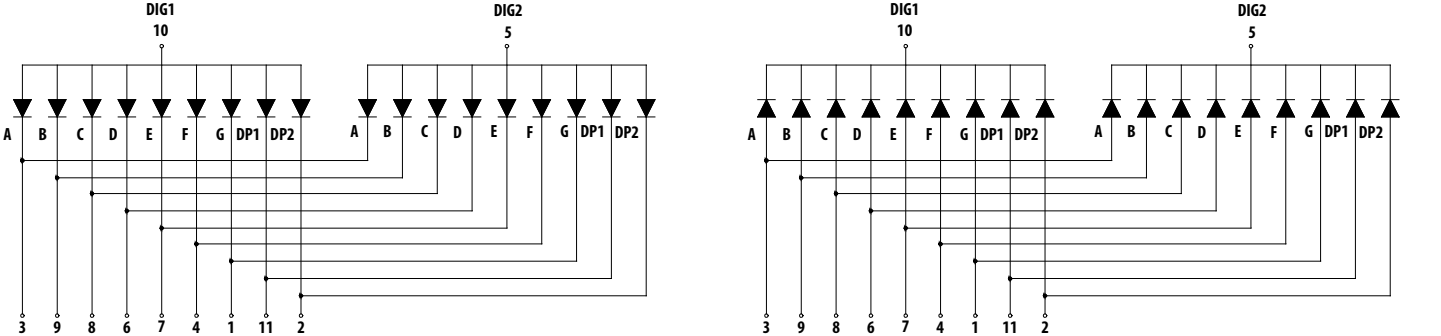
Pin Connection (Common Cathode)

Pin Number	Connection
1	CATHODE G
2	CATHODE DP2, DP4
3	CATHODE A
4	CATHODE F
5	COMMON ANODE DIG2
6	CATHODE D
7	CATHODE E
8	CATHODE C
9	CATHODE B
10	COMMON ANODE DIG1
11	CATHODE DP1, DP3

Pin Number	Connection
1	ANODE G
2	ANODE DP2, DP4
3	ANODE A
4	ANODE F
5	COMMON CATHODE DIG2
6	ANODE D
7	ANODE E
8	ANODE C
9	ANODE B
10	COMMON CATHODE DIG1
11	ANODE DP1, DP3

Internal Circuit Diagram (Common Anode)

Internal Circuit Diagram (Common Cathode)



Absolute Maximum Ratings at T_A = 25°C

Parameter	Green/Yellow/Red/Orange	Units
Power Dissipation Per Segment	65	mW
Peak Forward Current Per Segment (1/10 Duty Cycle, 0.1-ms pulse width)	100	mA
Continuous Forward Current Per Segment	25	mA
Derating Linearly From 25°C Per Segment	0.25	mA/°C
Reverse Voltage Per Segment	5	V
Operating Temperature Range	−40°C to +105°C	
Storage Temperature Range	−40°C to +105°C	

Electrical/Optical Characteristics at $T_A = 25^\circ\text{C}$

Green

Parameters	Symbol	Min.	Typ.	Max.	Units	Test Condition
Average Luminous Intensity	I_V	3.4	6	—	mcd	$I_F = 10\text{ mA}$
Emissions Wavelength	λ_p/λ_d	—	572/571	—	nm	$I_F = 20\text{ mA}$
Spectral Line Half-Width	$\Delta\lambda$	—	20	—	nm	$I_F = 20\text{ mA}$
Forward Voltage, Per Segment	V_F	—	2.1	2.6	V	$I_F = 20\text{ mA}$
Reverse Current, Per Segment	I_R	—	—	100	μA	$V_R = 5\text{V}$
Luminous Intensity Matching Ratio	I_{V-M}	—	—	2:1		$I_F = 10\text{ mA}$

Yellow

Parameters	Symbol	Min.	Typ.	Max.	Units	Test Condition
Average Luminous Intensity	I_V	3.4	8.0	—	mcd	$I_F = 10\text{ mA}$
Emissions Wavelength	λ_p/λ_d	—	591/589	—	nm	$I_F = 20\text{ mA}$
Spectral Line Half-Width	$\Delta\lambda$	—	15	—	nm	$I_F = 20\text{ mA}$
Forward Voltage, Per Segment	V_F	—	2.1	2.6	V	$I_F = 20\text{ mA}$
Reverse Current, Per Segment	I_R	—	—	100	μA	$V_R = 5\text{V}$
Luminous Intensity Matching Ratio	I_{V-M}	—	—	2:1		$I_F = 10\text{ mA}$

Red

Parameters	Symbol	Min.	Typ.	Max.	Units	Test Condition
Average Luminous Intensity	I_V	3.4	7.5	—	mcd	$I_F = 10\text{ mA}$
Emissions Wavelength	λ_p/λ_d	—	644/630	—	nm	$I_F = 20\text{ mA}$
Spectral Line Half-Width	$\Delta\lambda$	—	20	—	nm	$I_F = 20\text{ mA}$
Forward Voltage, Per Segment	V_F	—	2.0	2.6	V	$I_F = 20\text{ mA}$
Reverse Current, Per Segment	I_R	—	—	100	μA	$V_R = 5\text{V}$
Luminous Intensity Matching Ratio	I_{V-M}	—	—	2:1		$I_F = 10\text{ mA}$

Orange

Parameters	Symbol	Min.	Typ.	Max.	Units	Test Condition
Average Luminous Intensity	I_V	3.4	8.5	—	mcd	$I_F = 10\text{ mA}$
Emissions Wavelength	λ_p/λ_d	—	611/605	—	nm	$I_F = 20\text{ mA}$
Spectral Line Half-Width	$\Delta\lambda$	—	20	—	nm	$I_F = 20\text{ mA}$
Forward Voltage, Per Segment	V_F	—	2.1	2.6	V	$I_F = 20\text{ mA}$
Reverse Current, Per Segment	I_R	—	—	100	μA	$V_R = 5\text{V}$
Luminous Intensity Matching Ratio	I_{V-M}	—	—	2:1		$I_F = 10\text{ mA}$

Typical Electrical/Optical Characteristic Curves at T_A = 25°C

Green

Figure 1: Relative Luminous Intensity vs. Wavelength

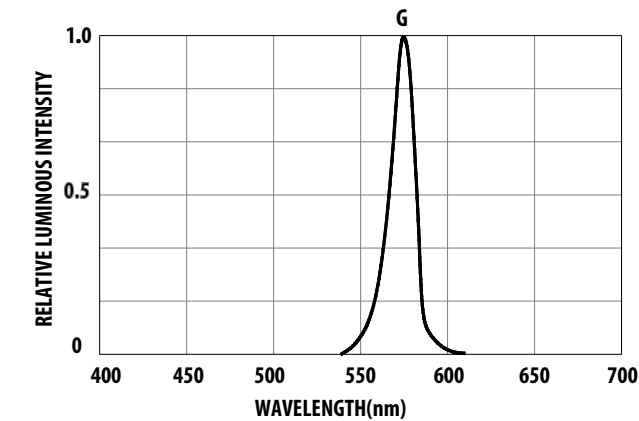


Figure 2: Relative Luminous Intensity vs. Forward Current

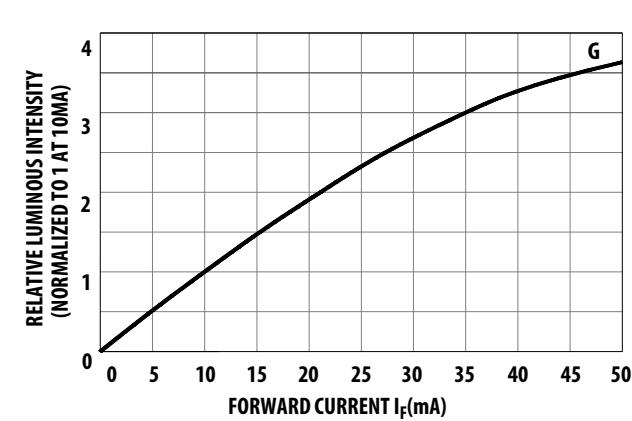


Figure 3: Allowable DC Current vs. Ambient Temperature

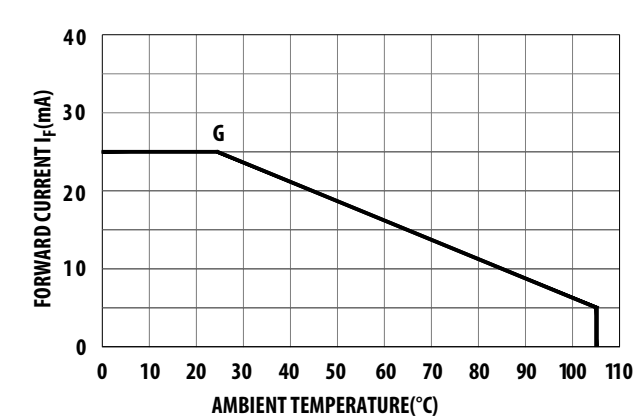
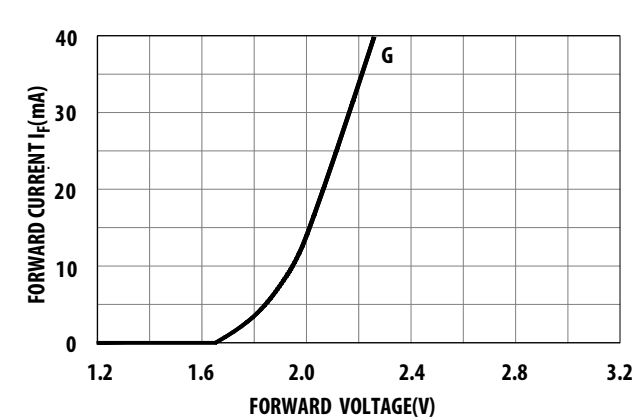


Figure 4: Forward Current vs. Forward Voltage



Typical Electrical/Optical Characteristic Curves at T_A = 25°C

Yellow

Figure 5: Relative Intensity vs. Wavelength

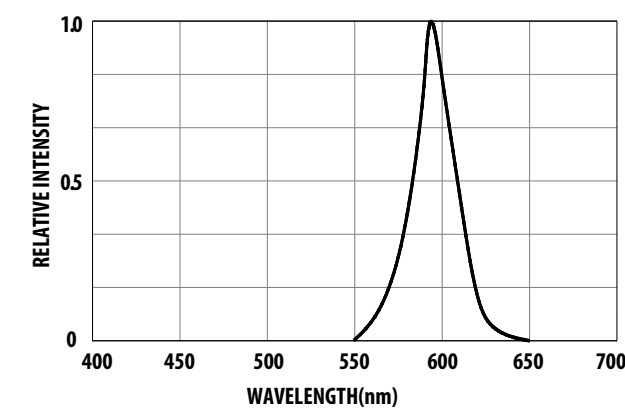


Figure 6: Relative Intensity vs. Forward Current

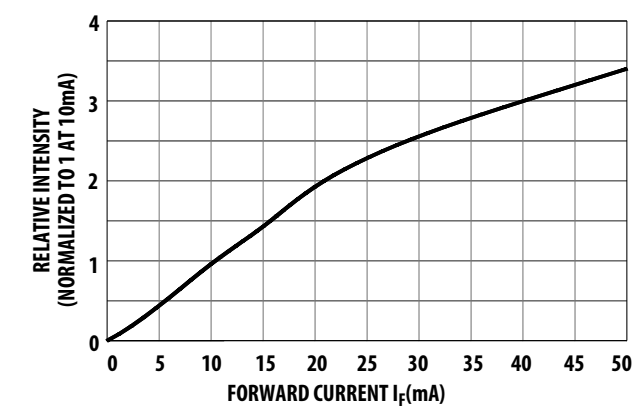


Figure 7: Allowable DC Current vs. Ambient Temperature

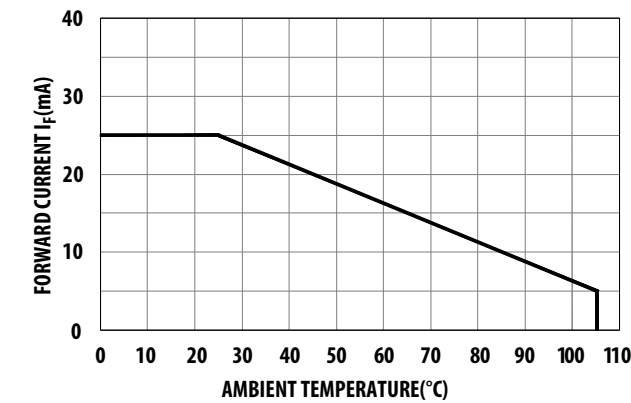
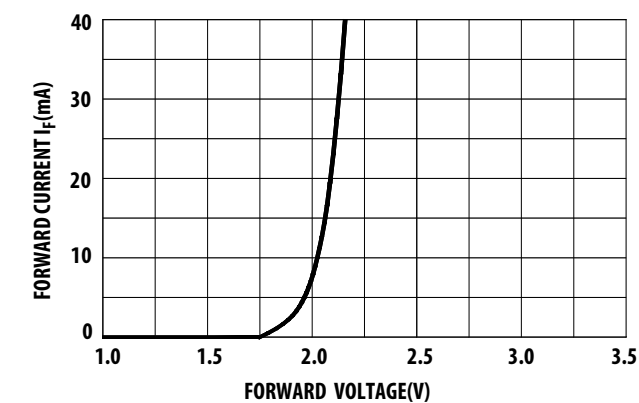


Figure 8: Forward Current vs. Forward Voltage



Typical Electrical/Optical Characteristic Curves at T_A = 25°C

Red

Figure 9: Relative Luminous Intensity vs. Wavelength

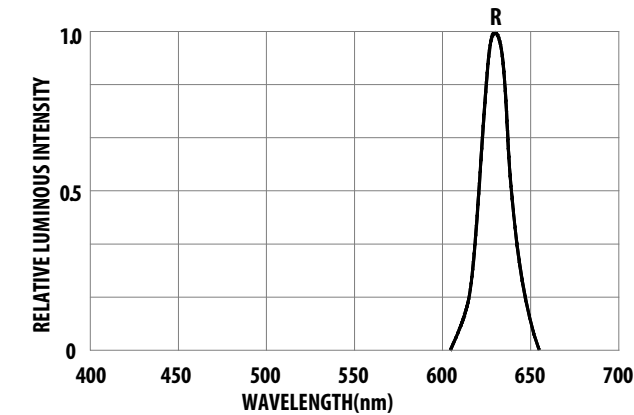


Figure 10: Relative Luminous Intensity vs. Forward Current

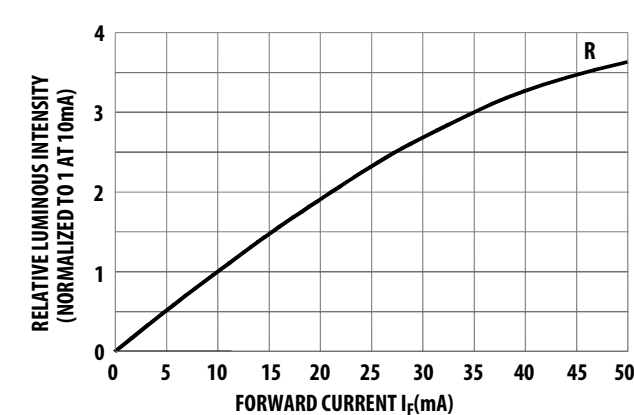


Figure 11: Allowable DC Current vs. Ambient Temperature

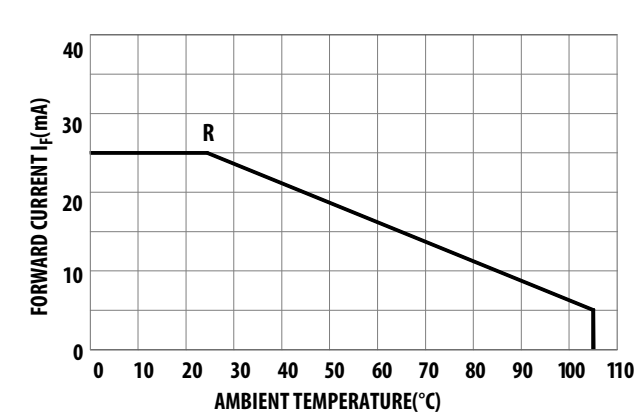
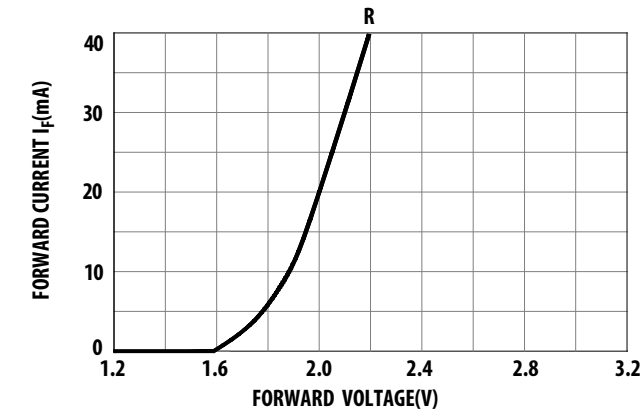


Figure 12: Forward Current vs. Forward Voltage



Typical Electrical/Optical Characteristic Curves at T_A = 25°C

Orange

Figure 13: Relative Intensity vs. Wavelength

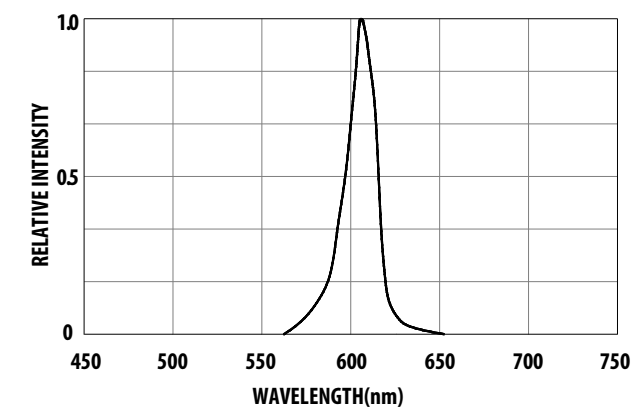


Figure 14: Relative Intensity vs. Forward Current

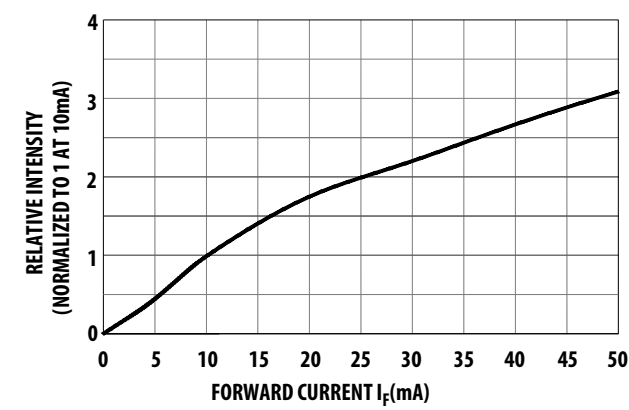


Figure 15: Allowable DC Current vs. Ambient Temperature

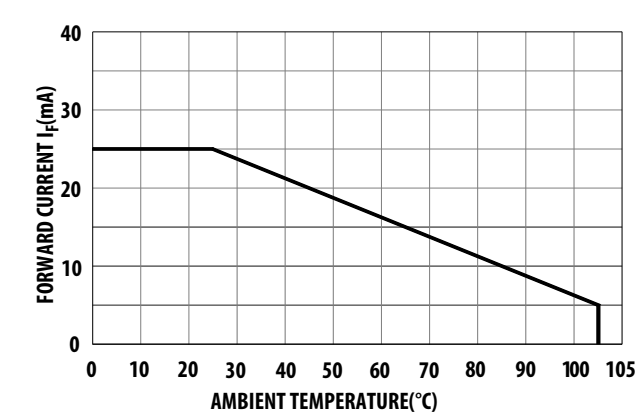
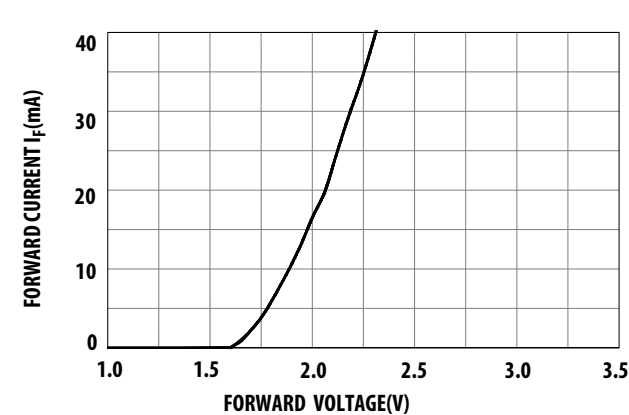


Figure 16: Forward Current vs. Forward Voltage



Intensity Bin Limits (mcd)

Yellow/Red/Orange/Green

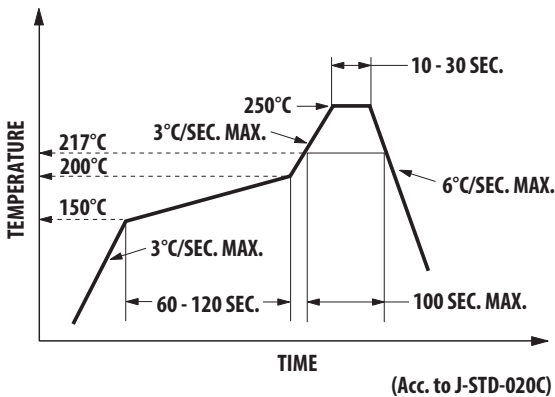
IV Bin Category	Min.	Max.
L	3.401	5.400
M	5.401	8.600
N	8.601	13.700
P	13.701	21.800

Tolerance: ± 15%.

NOTE: Bin categories are established for classification of products. Products may not be available in all categories. Contact your Broadcom representative for information on currently available bins.

SMT Soldering Profile

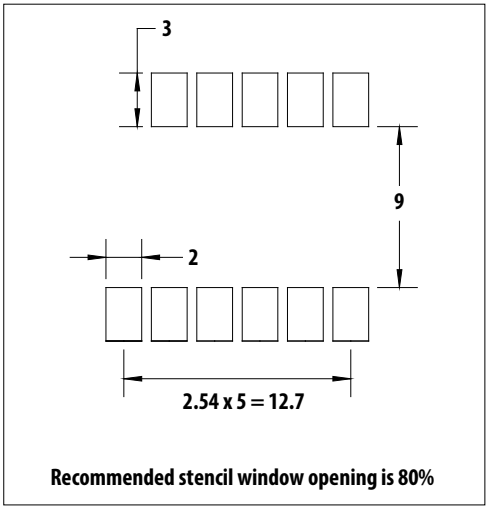
Pb-Free Reflow Soldering Profile



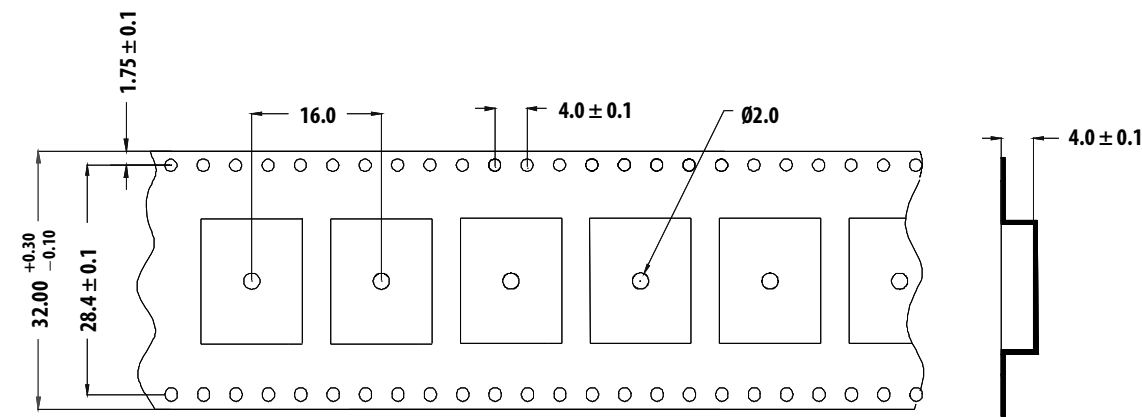
NOTE:

1. The peak temperature refers to the peak package body temperature.
2. The number of reflow processes shall be limited to a maximum of twice only. A cooling process to normal temperature is required between the first and second soldering processes.

Recommended Soldering Pattern (Unit: mm)



Tape Specification (Unit: mm)



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